IPC ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1					Form Type * Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				als and Mfg	Informati	on		
upplier Inform	ation													
Company name*			Company unique ID			J	Unique ID Authority				Response Date*			
onsemi											2024-05-19			
Contact Name			Title - Contact			I	Phone - Contact*				Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative			I	Phone - Representative*			Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Requester Item Number		Mfr Item Number Mfr		Mfr Item Name	Mfr Item Name		Effective Date	Version	N	Manufacturing Site		ight*	UOM	Unit Type
		NCH-RSL15-512- 101Q40-ACG RSL15 QFN 512kH		3		2024-05-19	9 TWU		68.	7615	mg	Each		
lanufacturing l	Proccess Information	on												
Terminal Plating / Grid Array Material Termina		rminal Base Alloy J-STD-020 MSL Rat		Rating	Peak Process Body Temperature Max Time at Peal			k Temperature Number of Reflow Cycles						
Matte Tin (Sn) - annealed		C	CU Alloy 3				260		C	30	seconds	3		
omments														
TTENTION: MSL	3 Rated item requires I	Bake and D	ry Pack (afte	r electrical test)						·				
or more informatio	on regarding material co	mposition p	olease refer t	o page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.8409	mg	Supplier	Silicon (Si)	7440-21-3		2.8409	mg
Die Attach	0.7341	mg	Supplier	Isobornyl Methacrylate	7534-94-3		0.044	mg
			Supplier	Silver (Ag)	7440-22-4		0.5983	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.044	mg
			Supplier	Misc.	Proprietary Data		0.0037	mg
			Supplier	Tricyclo[5.2.1.02,6]decanedimethanol Diacrylate (C18H24O4)	42594-17-2		0.044	mg
Lead Frame	29.4757	mg	Supplier	Silver (Ag)	7440-22-4		0.3213	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0354	mg
			Supplier	Iron (Fe)	7439-89-6		0.6838	mg
			Supplier	Copper (Cu)	7440-50-8		28.4264	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0088	mg
Mold Compound-Black	33.0806	mg		Epoxy resin	proprietary data		1.654	mg
			Supplier	Phenolic Resin	Proprietary Data		0.7609	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		1.654	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1323	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.7609	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		28.1185	mg
Plating	2.1313	mg	Supplier	Tin (Sn)	7440-31-5		2.1313	mg
Wire Bond - Au	0.4989	mg	Supplier	Gold (Au)	7440-57-5		0.4989	mg